PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Robert Renfro	09/28/2007
Rodger Smith	09/28/2007

RECEIVING PARTY DATA

Name:	SOLAR COMMUNICATIONS INTERNATIONAL, INC.
Street Address:	8885 Rio San Diego Drive, Suite 207
City:	San Diego
State/Country:	CALIFORNIA
Postal Code:	92108

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	11778476

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER: 109482-018UTL

NAME OF SUBMITTER: Alan C. Gordon

Total Attachments: 1

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PATENT REEL: 019913 FRAME: 0898

Attorney Docket No.: 109482-018UTL

ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in SYSTEM, METHOD AND APPARATUS FOR SUPPORTING AND CONCEALING RADIO ANTENNAS (Application Number: 11/778,476, Filing Date: July 16, 2007) for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address.

AND WHEREAS, SOLAR COMMUNICATIONS INTERNATIONAL, INC., a corporation, with offices at 8885 Rio San Diego Drive, Suite 207, San Diego, CA 92108 (hereinafter referred to as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, their successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignees of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or their designee(s), as ASSIGNEE or their successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at their own expense;

And I further agree that ASSIGNEE will, upon their request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

This assignment executed on the dates indicated below.

Robert Renfro	
Name of first inventor	
San Diego, CA Residence of first inventor	9/28/07
Signature of first inventor	Date of Assignment
Rodger Smith	
Name of second inventor	
San Diego, CA Residence of second inventor	
W. See	9-28-07
Signature of second inventor	Date of Assignment

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